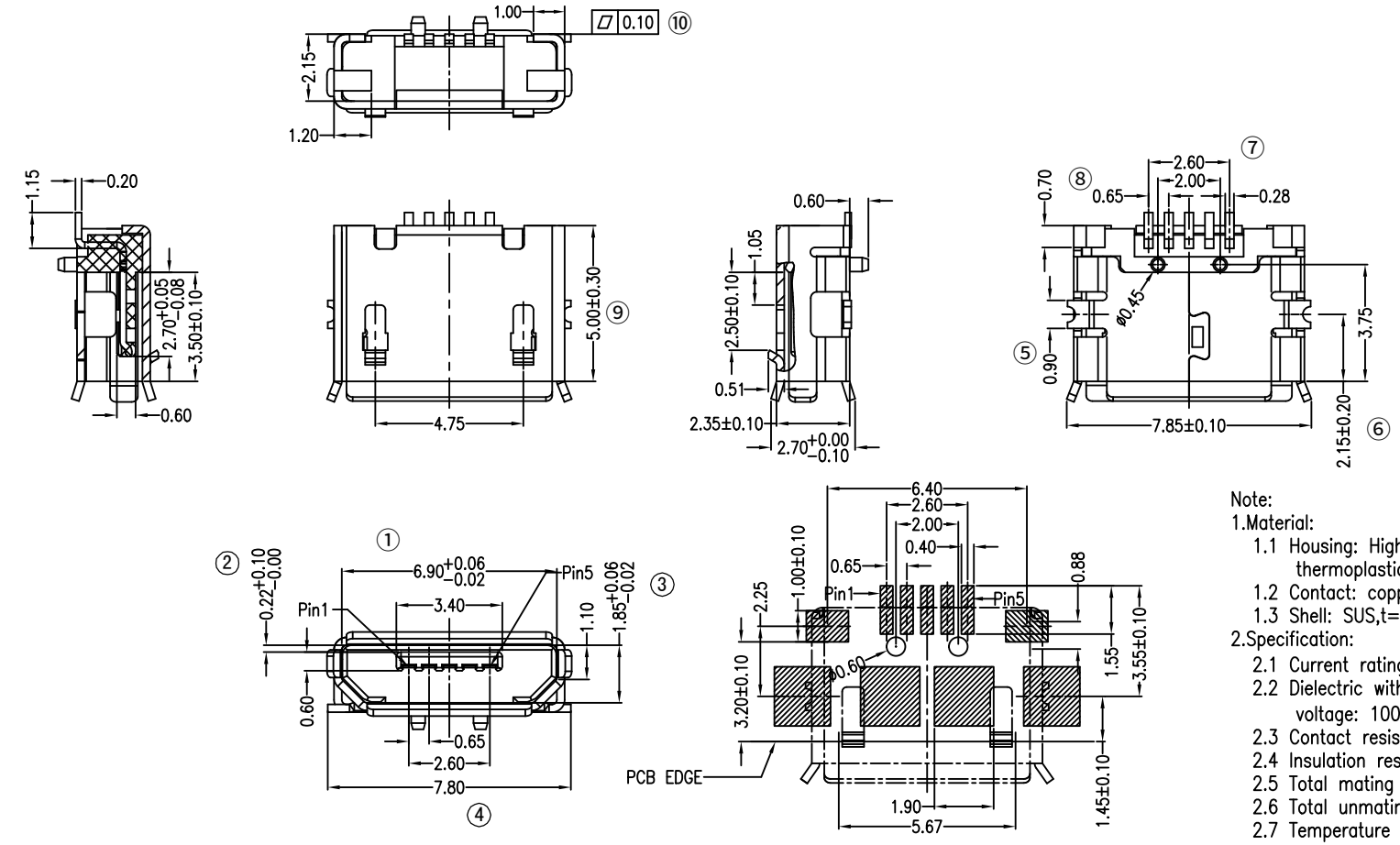
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE



Note:
1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: SUS,t=0.25mm

2.Specification:
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min
- 2.7 Temperature range: -30°C~80°C

RECOMMANDED PCB LAYOUT PCB图仅供参考

		MATERAL:	WFDCONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD
MODEL NO: XX		FINSH:	
UNIT: MM	SIZE: A4	COLOR:	TITLE: Micro usb5s B Type Smt有焊脚2.0中心柱加长0.4
TOLERANCE UNSPECIFIED .x ±0.15 .xx ±0.10 .xxx ±0.05 Ang. ±1°		DR: Liu Miao	PART NO: USB-F0565-0M01C REV: A
		CHK: David	SCALE: 5:1 DATE: 2014.12.19
		APP:	